

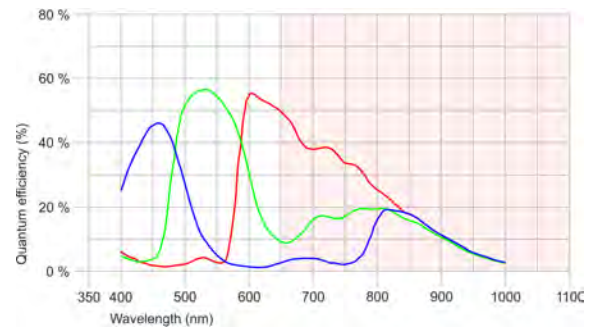
NEW GENERATION



Specification

Sensor

Sensor type	CMOS Color
Shutter	Global Shutter
Sensor characteristic	Linear
Readout mode	Progressive scan
Pixel Class	1.6 MP
Resolution	1.57 Mpix
Resolution (h x v)	1448 x 1086 Pixel
Aspect ratio	4:3
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/3"
Optical Size	4.995 mm x 3.746 mm
Optical sensor diagonal	6.24 mm (1/2.56")
Pixel size	3.45 µm
Manufacturer	Sony
Sensor Model	IMX273LQR-C
Gain (master/RGB)	24x/4x
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	256 / 8
AOI image height / step width	4 / 2
AOI position grid (horizontal/vertical)	4 / 2
Binning horizontal	increased frame rate
Binning vertical	increased frame rate
Binning method	Mono
Binning factor	2
Subsampling horizontal	same frame rate
Subsampling vertical	same frame rate
Subsampling method	M/C automatic
Subsampling factor	2, 4, 6, 8, 16



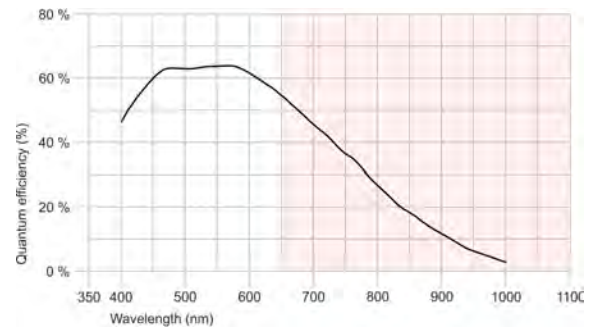
NEW GENERATION



Specification

Sensor

Sensor type	CMOS Mono
Shutter	Global Shutter
Sensor characteristic	Linear
Readout mode	Progressive scan
Pixel Class	1.6 MP
Resolution	1.57 Mpix
Resolution (h x v)	1448 x 1086 Pixel
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UI-5040SE-C-HQ Rev.4 (AB02616) / UI-5040SE-M-GL Rev.4 (AB02617)

Model

Pixel clock range	30 MHz - 140 MHz
Frame rate freerun mode	73
Frame rate trigger (continuous)	73
Frame rate trigger (maximum)	73
Exposure time (minimum - maximum)	0.025 ms - 999 ms
Long exposure (maximum)	30000 ms
Power consumption	1.8 W - 3.1 W
Image memory	128 MB
Special features	IDS line scan mode, Sensor source gain, Multi-AOI

Ambient conditions

The temperature values given below refer to the outer device temperature of the camera housing.

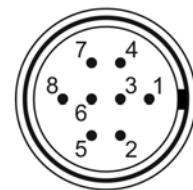
Device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Device temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	GigE RJ45, screwable
I/O connector	8-pin Hirose connector (HR25-7TR-8PA(73))
Power supply	12 V - 24 V or PoE

Pin assignment I/O connector

1	Ground (GND)
2	Flash output with optocoupler (-)
3	General Purpose I/O (GPIO) 1
4	Trigger input with optocoupler (-)
5	Flash output with optocoupler (+)
6	General Purpose I/O (GPIO) 2
7	Trigger input with optocoupler (+)
8	Input power supply (VCC) 12-24 V DC



Camera rear view

Design

Lens Mount	C-Mount
IP code	IP30
Dimensions H/W/L	34.0 mm x 44.0 mm x 47.0 mm
Mass	104.5 g